

BUT12AX

Silicon diffused power transistor

Rev. 01 — 16 June 2004

Product data

1. Product profile

1.1 Description

High voltage, high speed, NPN power transistor in a plastic package.

1.2 Features

Isolated package

Fast switching.

1.3 Applications

Inverters

Motor control systems

Switching regulators

DC-to-DC converters.

1.4 Quick reference data

V_{CESM} ≤ 1000 V

Arr P_{tot} \leq 23 W

 $I_C \le 8 A$

 $t_f \le 0.8 \ \mu s.$

2. Pinning information

Table 1: Pinning - SOT186A (TO-220F), simplified outline and symbol

Pin	Description	Simplified outline	Symbol	
1	base (b)	_	_	
2	collector (c)	mb	2 	
3	emitter (e)	000	1 —	
mb	mounting base; isolated		мввоов 3	
		1 2 3 MBK110		
		SOT186A (TO-220F)	





3. Ordering information

Table 2: Ordering information

Type number	Package	ackage								
	Name	Description	Version							
BUT12AX	TO-220F	Plastic single-ended package; isolated heatsink mounted; 1 mounting hole; 3 leads.	SOT186A							

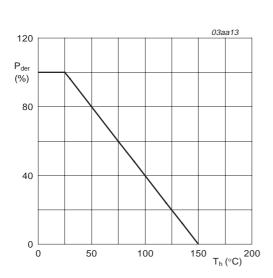
4. Limiting values

Table 3: Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

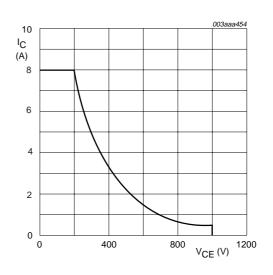
Symbol	Parameter	Conditions	Min	Max	Unit
V_{CESM}	peak collector-emitter voltage	$V_{BE} = 0 V$	-	1000	V
V_{CEO}	collector-emitter voltage	base open circuit	-	450	V
I _C	collector current	Figure 2 and 3	-	8	Α
I _{Csat}	collector saturation current		-	5	Α
I_{CM}	peak collector current	Figure 3	-	20	Α
I_{B}	base current (DC)		-	4	Α
I_{BM}	peak base current		-	6	Α
P _{tot}	total power dissipation	T _h = 25 °C; Figure 1	[1]	23	W
T _{stg}	storage temperature		-65	+150	°C
Tj	junction temperature		-	+150	°C

^[1] Mounted without heatsink compound.



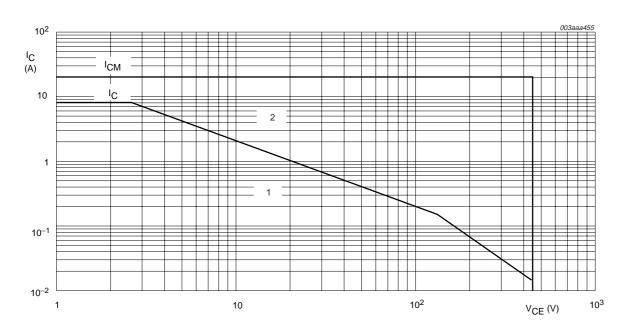
$$P_{der} = \frac{P_{tot}}{P_{tot(25^{\circ}C)}} \times 100\%$$

Fig 1. Normalized total power dissipation as a function of heatsink temperature.



 $V_{BE} = -1 \text{ V to } -5 \text{ V; } T_h = 100 \text{ }^{\circ}\text{C}.$

Fig 2. Reverse bias safe operating area; continuous collector current as a function of collector-emitter voltage.



 $T_h = 25 \, ^{\circ}C$

- 1 Region of permissible DC operation.
- 2 Permissible extension for repetitive operation.

Fig 3. Forward bias safe operating area; continuous and peak collector currents as a function of collector-emitter voltage.



5. Thermal characteristics

Table 4: Thermal characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
$R_{th(j-h)}$	thermal resistance from junction to heatsink	Mounted without heatsink compound	[1]	-	-	5.5	K/W
		Mounted with heatsink compound	[1]	-	-	3.9	K/W
R _{th(j-a)}	thermal resistance from junction to ambient			-	55	-	K/W

^[1] External heatsink connected to mounting base.

6. Characteristics

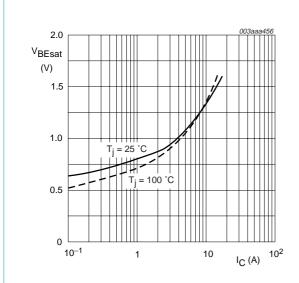
Table 5: Characteristics

 $T_i = 25 \,^{\circ}C$ unless otherwise specified.

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Static ch	naracteristics						
V _{CEOsus}	collector-emitter sustaining voltage	$I_C = 100 \text{ mA}$; $I_{Boff} = 0 \text{ A}$; $L = 25 \text{ mH}$; Figure 9 and 10		400	-	-	V
V _{CEsat}	collector-emitter saturation voltage	I _C = 5 A; I _B = 1 A; Figure 5		-	-	1.5	V
V_{BEsat}	base-emitter saturation voltage	I _C = 5 A; I _B = 1 A; Figure 4		-	-	1.5	V
I _{CES}	collector-emitter cut-off current	$V_{CE} = V_{CESM}; V_{BE} = 0 V$					
		T _j = 25 °C	[1]	-	-	1	mΑ
		T _j = 125 °C	[1]	-	-	3	mΑ
h _{FE}	DC current gain	V _{CE} = 5 V; Figure 8					
		I _C = 10 mA		10	18	35	
		I _C = 1 A		10	20	35	V V V
Dynamic	characteristics						
t _{on}	turn-on time	I _{Con} = 5 A; I _{Bon} = I _{Boff} = 1 A; resistive load; Figure 11 and 12		-	-	1	μs
t _s	carrier storage time	I _{Con} = 5 A; I _{Bon} = I _{Boff} = 1 A; resistive load; Figure 11 and 12	[2]	-	-	4	μs
		I_{Con} = 5 A; I_{Bon} = 1 A; V_{CL} = 250 V; T_{mb} = 100 °C; inductive load; Figure 13 and 14		-	1.9	2.5	V V mA mA μs μs μs
t _f	fall time	I _{Con} = 5 A; I _{Bon} = I _{Boff} = 1 A; resistive load; Figure 11 and 12		-	-	0.8	μs
		$I_{Con} = 5$ A; $I_{Bon} = 1$ A; $V_{CL} = 300$ V; $T_{mb} = 100$ °C; inductive load; Figure 13 and 14		-	200	300	ns

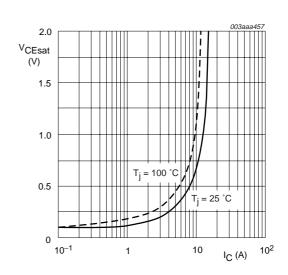
^[1] Measured with a half-sinewave voltage.

^[2] turn-off storage time



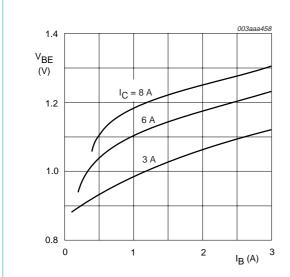
 T_i = 25 °C and 100 °C

Fig 4. Base-emitter saturation voltage as a function of collector current; typical values.



 $T_i = 25$ °C and 100 °C

Fig 5. Collector-emitter saturation voltage as a function of collector current; typical values.



T_i = 25 °C

Fig 6. Base-emitter voltage as a function of base current; typical values.

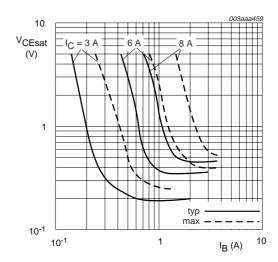
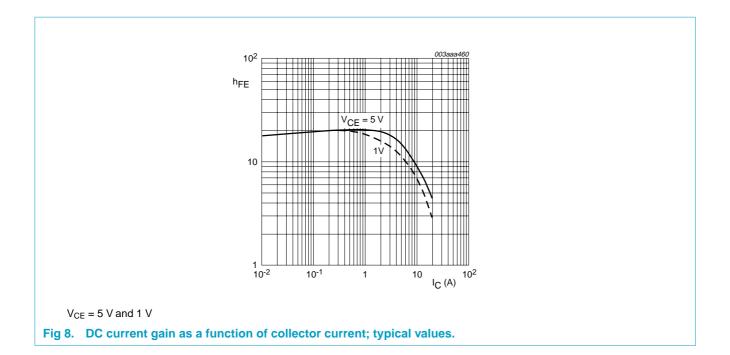
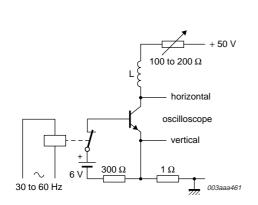


Fig 7. Collector-emitter saturation voltage as a function base current; typical and maximum values.





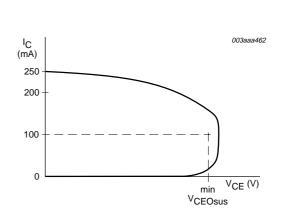
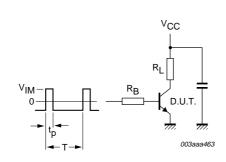


Fig 9. Test circuit for collector-emitter sustaining voltage.

Fig 10. Oscilloscope display for collector-emitter sustaining voltage.



 V_{CC} = 250 V; t_p = 20 $\mu s;~V_{IM}$ = -6 V to 8 V; t_p/T = 0.01. The values of R_B and R_L are selected in accordance with I_{Con} and I_{Bon} requirements.

Fig 11. Test circuit for resistive load switching times

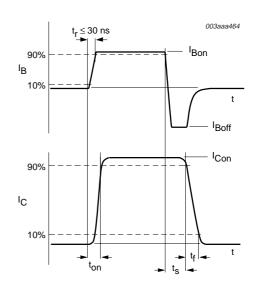
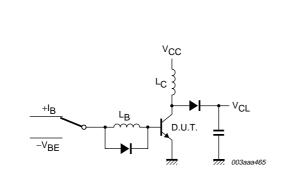


Fig 12. Switching time waveforms with resistive load.





 $V_{CL} \leq$ 1000 V; V_{CC} = 30 V; V_{BE} = -1 V to -5 V; L_B = 1 μH ; L_C = 200 μH

Fig 13. Test circuit for inductive load switching and reverse bias safe operating area.

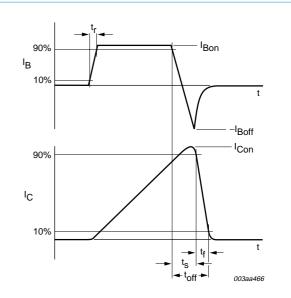


Fig 14. Switching time waveforms with inductive load.

7. Isolation characteristics

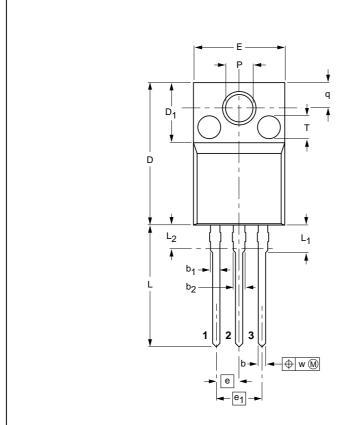
Table 6: Isolation characteristics

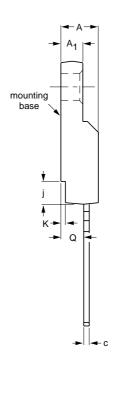
Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
$V_{isol(RMS)M}$	Peak RMS isolation voltage from all three terminals to external heatsink.	$f = 50$ to 60 Hz; sinusoidal waveform; RH \leq 65%; clean and dust-free.	-	-	2500	V
C _{c-h}	Capacitance from collector to external heatsink.		-	12	-	pF

8. Package outline

Plastic single-ended package; isolated heatsink mounted; 1 mounting hole; 3 lead TO-220 'full pack'

SOT186A





0 5 10 mm

DIMENSIONS (mm are the original dimensions)

UNIT	Α	A ₁	b	b ₁	b ₂	С	D	D ₁	E	е	e ₁	j	к	L	L ₁	L ₂ ⁽¹⁾ max.	Р	Q	q	T ⁽²⁾	w
mm	4.6 4.0	2.9 2.5	0.9 0.7	1.1 0.9	1.4 1.0	0.7 0.4	15.8 15.2	6.5 6.3	10.3 9.7	2.54	5.08	2.7 1.7	0.6 0.4	14.4 13.5	3.30 2.79	3	3.2 3.0	2.6 2.3	3.0 2.6	2.5	0.4

Notes

- 1. Terminal dimensions within this zone are uncontrolled. Terminals in this zone are not tinned.
- 2. Both recesses are \varnothing 2.5 \times 0.8 max. depth

OUTLINE		REFER	EUROPEAN	ISSUE DATE			
VERSION	IEC	JEDEC	JEITA		PROJECTION	1330E DATE	
SOT186A		3-lead TO-220F				-02-03-12- 02-04-09	

Fig 15. SOT186A (TO-220F).

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9. Revision history

Table 7: Revision history

Rev	Date	CPCN	Description
01	20040616	-	Product data (9397 750 13442)



10. Data sheet status

Level	Data sheet status ^[1]	Product status ^{[2][3]}	Definition
I	Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
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- [1] Please consult the most recently issued data sheet before initiating or completing a design.
- [2] The product status of the device(s) described in this data sheet may have changed since this data sheet was published. The latest information is available on the Internet at URL http://www.semiconductors.philips.com.
- [3] For data sheets describing multiple type numbers, the highest-level product status determines the data sheet status.

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